PMP10709_BOM

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
!PCB	1		XX####	Any	Printed Circuit Board	
AGND, DAC, EN, PGOOD, SYNC, Vin	6	SMT	5015	Keystone	Test Point, Miniature, SMT	Testpoint_Keystone_Miniature
C1, C4, C5, C11, CT1	5	100pF	GRM1885C1H101JA01D	MuRata	CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603	0603
C13	1	47pF	GRM1885C1H470JA01D	MuRata	CAP, CERM, 47pF, 50V, +/-5%, C0G/NP0, 0603	0603
C14	1	100pF	CGA3E2NP01H101J080AA	TDK	CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603	0603
C15, Cbias, Cin8	3	0.22uF	C1608X7R1H224K080AB	TDK	CAP, CERM, 0.22uF, 50V, +/-10%, X7R, 0603	0603
C16, C17	2	4700pF	C2012X7R2A472K	TDK	CAP, CERM, 4700 pF, 100 V, +/- 10%, X7R, 0805	0805
Cb1, Cb2	2	0.1uF	GCM188R71H104KA57D	MuRata	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	0603
Cc1	1	6800pF	06031C682KAT2A	AVX	CAP, CERM, 6800 pF, 100 V, +/- 10%, X7R, 0603	0603
Cc2	1	470pF	06031C471JAT2A	AVX	CAP, CERM, 470 pF, 100 V, +/- 5%, X7R, 0603	0603
Cd	1	0	RC0603JR-070RL	Yageo America	RES, 0, 5%, 0.1 W, 0603	0603
Cin1, Cin2, Cin3, Cin4, Cin5, Co1, Co2, Co3, Co4, Co5	10	10uF	GRM32ER71H106KA12L	MuRata	CAP, CERM, 10uF, 50V, +/-10%, X7R, 1210, CAP, CERM, 10uF, 50V, +/-10%, X7R, 1210, CAP, CERM, 10uF, 50V, +/-10%, X7R, 1210, CAP, CERM, 10uF, 50V, +/-10%, X7R, 1210, CAP, CERM, 10uF, 50V, +/-10%, X7R, 1210, CAP, CERM, 10 µF, 50 V, +/- 10%, X7R, 1210, CAP, CERM, 10 µF, 50 V, +/- 10%, X7R, 1210, CAP, CERM, 10 µF, 50 V, +/- 10%, X7R, 1210, CAP, CERM, 10 µF, 50 V, +/- 10%, X7R, 1210, CAP, CERM, 10 µF, 50 V, +/- 10%, X7R, 1210	1210
Cin7, Cin9, Co7, Co8	4	100uF	25SVPF100M	Panasonic	CAP, AL, 100 µF, 25 V, +/- 20%, 0.024 ohm, SMD	8.0x7.0mm
Css	1	0.047uF	GRM188R71H473KA61D	MuRata	CAP, CERM, 0.047 µF, 50 V, +/- 10%, X7R, 0603	0603
Cvcc	1	1uF	GRM188R71C105KA12D	MuRata	CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603	0603
D1	1	30V	BAT54HT1G	ON Semiconductor	Diode, Schottky, 30V, 0.2A, SOD-323	SOD-323
D2, D3	2	100V	BAS516,115	NXP Semiconductor	Diode, Switching, 100V, 0.25A, SOD-523	SOD-523
D4, D5	2	28V	SMBJ28A-13-F	Diodes Inc.	Diode, TVS, Uni, 28 V, 600 W, SMB	SMB
D6	1	15V	MMSZ5245B-7-F	Diodes Inc.	Diode, Zener, 15 V, 500 mW, SOD-123	SOD-123
FID1, FID2, FID3	3		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
H1, H2, H3, H4	4		NY PMS 440 0025 PH	B&F Fastener Supply	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw
H5, H6, H7, H8	4		1902C	Keystone	Standoff, Hex, 0.5"L #4-40 Nylon	Standoff
H9, H10, H11, H12	4		SJ-5303 (CLEAR)	3M	Bumpon, Hemisphere, 0.44 X 0.20, Clear	Transparent Bumpon
J1, J2, J2, J4	4		108-0740-001	Emerson Network Power	Standard Banana Jack, Uninsulated, 15A	Banana Jack
L1	1	3.3uH	IHLP5050FDER3R3M01	Vishay-Dale	Inductor, Shielded Drum Core, Powdered Iron, 3.3 µH, 18 A, 0.0057 ohm, SMD	IHLP-5050FD
LBL1	1		THT-14-423-10	Brady	Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650"H x 0.200"W
Q1, Q2	2	-60V	SQJ461EP	Vishay-Siliconix	MOSFET, P-CH, -60 V, 30 A, PowerPAK_SO-8L	PowerPAK_SO-8L
Q3	1	60V	SQ2360EES-T1-GE3	Vishay-Siliconix	MOSFET, N/P-CH, 60 V, 4.4 A, SOT-23	SOT-23
QH1, QL1	2	60V	CSD18531Q5A	Texas Instruments	MOSFET, N-CH, 60 V, 19 A, SON 5x6mm	SON 5x6mm
QH2, QL2	2	30V	CSD17573Q5B	Texas Instruments	MOSFET, N-CH, 30 V, 100 A, SON 5x6mm	SON 5x6mm
R1	1	200k	RC0603FR-07200KL	Yageo America	RES, 200k ohm, 1%, 0.1W, 0603	0603
R2	1	52.3k	RC0603FR-0752K3L	Yageo America	RES, 52.3 k, 1%, 0.1 W, 0603	0603
R3, R5, R6	3	10.0	RC0603FR-0710RL	Yageo America	RES, 10.0 ohm, 1%, 0.1W, 0603	0603
R4	1	1.00k	RC0603FR-071KL	Yageo America	RES, 1.00k ohm, 1%, 0.1W, 0603	0603

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
R7	1	DNP	CRCW06030000Z0EA	Vishay-Dale	RES, 0 ohm, 5%, 0.1W, 0603	0603
R8	1	200k	CRCW0603200KFKEA	Vishay-Dale	RES, 200 k, 1%, 0.1 W, 0603	0603
R10	1	8.06k	CRCW06038K06FKEA	Vishay-Dale	RES, 8.06 k, 1%, 0.1 W, 0603	0603
R12	1	100k	RC0603FR-07100KL	Yageo America	RES, 100k ohm, 1%, 0.1W, 0603	0603
R13, R14	2	100	RC0603FR-07100RL	Yageo America	RES, 100 ohm, 1%, 0.1W, 0603	0603
R15	1	25.5k	RG1608P-2552-B-T5	Susumu Co Ltd	RES, 25.5 k, 0.1%, 0.1 W, 0603	0603
R16	1	50	CRCW060350R0FKEA	Vishay-Dale	RES, 50, 1%, 0.1 W, 0603	0603
R17, R18	2	100	CRCW0603100RFKEA	Vishay-Dale	RES, 100, 1%, 0.1 W, 0603	0603
R19, R24	2	100k	CPF0603B100KE	TE Connectivity	RES, 100 k, 0.1%, 0.063 W, 0603	0603
R20	1	20k	CRCW060320K0JNEA	Vishay-Dale	RES, 20 k, 5%, 0.1 W, 0603	0603
R21	1	30.1k	CRCW060330K1FKEA	Vishay-Dale	RES, 30.1 k, 1%, 0.1 W, 0603	0603
R22	1	20.0k	CRCW060320K0FKEA	Vishay-Dale	RES, 20.0 k, 1%, 0.1 W, 0603	0603
R23	1	2.00k	CRCW06032K00FKEA	Vishay-Dale	RES, 2.00 k, 1%, 0.1 W, 0603	0603
Rc	1	5.49k	CRCW06035K49FKEA	Vishay-Dale	RES, 5.49 k, 1%, 0.1 W, 0603	0603
Rh1, Rl1	2	0	CRCW06030000Z0EA	Vishay-Dale	RES, 0 ohm, 5%, 0.1W, 0603	0603
Rpg	1	20.0k	RC0603FR-0720KL	Yageo America	RES, 20.0 k, 1%, 0.1 W, 0603	0603
Rs1	1	0.007	KRL6432E-M-R007-F-T1	Susumu	RES 0.007 OHM 3W 1% 2512 WIDE	Wide 2512 (6432 Metric), 1225
Rs2	1	0.009	73M2R009F	CTS Resistor	RES, 0.009, 1%, 2 W, 2512	2512
RT1	1	69.8k	CRCW060369K8FKEA	Vishay-Dale	RES, 69.8 k, 1%, 0.1 W, 0603	0603
U1	1		LM5175PWP	Texas Instruments	42V Wide VIN 4-Switch Synchronous Buck-Boost Controller, PWP0028F	PWP0028F
U2	1		TLVH431AQDBVRA	Texas Instruments	Low-Voltage Adjustable Precision Shunt Regulator, 80 mA, -40 to 125 degC, 5-pin SOT-23 (DBV), Green (RoHS & no Sb/Br)	DBV0005A

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265